

CD74HCT258

High Speed CMOS Logic Quad 2-Input Multiplexer with Three-State Inverting Outputs

November 1997

Features

- · Buffered Inputs
- Typical Propagation Delay = 7ns at V_{CC} =5V,
 C_L = 15pF, T_Δ = 25°C
- Fanout (Over Temperature Range)
 - Standard Outputs......10 LSTTL Loads
 - Bus Driver Outputs 15 LSTTL Loads
- Wide Operating Temperature Range ...-55°C to 125°C
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HCT Types
 - 4.5V to 5.5V Operation
 - Direct LSTTL Input Logic Compatibility,
 V_{IL}= 0.8V (Max), V_{IH} = 2V (Min)
 - CMOS Input Compatibility, $I_I \le 1\mu A$ at V_{OL} , V_{OH}

Description

The Harris CD74HCT258 is a quad 2-input multiplexer which selects four bits of data from two sources under the control of a common Select Input (S). The Output Enable input $\overline{(OE)}$ is active LOW. When \overline{OE} is HIGH, all of the outputs $\overline{(1Y-4Y)}$ are in the high impedance state regardless of all other input conditions.

Moving data from two groups of registers to four common output busses is a common use of the 258. The state of the Select input determines the particular register from which the data comes. It can also be used as a function generator.

Ordering Information

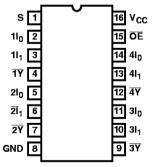
PART NUMBER	TEMP. RANGE (^O C)	PACKAGE	PKG. NO.	
CD74HCT258E	-55 to 125	16 Ld PDIP	E16.3	

NOTES:

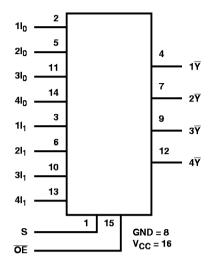
- 1. When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.
- Wafer and die for this part number is available which meets all electrical specifications. Please contact your local sales office or Harris customer service for ordering information.

Pinout

CD74HCT258 (PDIP) TOP VIEW



Functional Diagram



TRUTH TABLE

OUTPUT ENABLE	SELECT INPUT	DATA I	ОИТРИТ	
ŌĒ	s	l ₀	7	
Н	Х	Х	Х	Z
L	L	L	Х	Н
L	L	Н	Х	L
L	Н	Х	L	Н
L	Н	Х	Н	L

NOTE: H = High Voltage Level L = Low Voltage Level X = Don't Care

Z = High Impedance, OFF State

CD74HCT258

Absolute Maximum Ratings

DC Supply Voltage, V _{CC} 0.5V to 7V
DC Input Diode Current, I _{IK}
For $V_1 < -0.5V$ or $V_1 > V_{CC} + 0.5V$ ±20mA
DC Output Diode Current, IOK
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ ±20mA
DC Drain Current, per Output, IO
For -0.5V < V _O < V _{CC} + 0.5V±35mA
DC Output Source or Sink Current per Output Pin, IO
For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$
DC V _{CC} or Ground Current, I _{CC} ±70mA

Thermal Information

Thermal Resistance (Typical, Note 3)	θ _{JA} (°C/W)
PDIP Package	100
Maximum Junction Temperature	150°C
Maximum Storage Temperature Range	65°C to 150°C
Maximum Lead Temperature (Soldering 10s)	300°C
(SOIC - Lead Tips Only)	

Operating Conditions

Temperature Range, T _A 55°C to 125°C
Supply Voltage Range, V _{CC}
HCT Types
DC Input or Output Voltage, V _I , V _O 0V to V _{CC}
Input Rise and Fall Time
2V
4.5V 500ns (Max
6V

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE

3. $\theta_{\mbox{\scriptsize JA}}$ is measured with the component mounted on an evaluation PC board in free air.

DC Electrical Specifications

			ST ITIONS			25°C		-40°C 7	O 85°C	-55°C T	O 125 ⁰ C	
PARAMETER	SYMBOL	V _I (V)	I _O (mA)	V _{CC} (V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
High Level Input Voltage	V _{IH}	-	-	4.5 to 5.5	2	-		2	-	2	-	٧
Low Level Input Voltage	V _{IL}	-	-	4.5 to 5.5	-	-	8.0	-	0.8	-	0.8	٧
High Level Output Voltage CMOS Loads	V _{ОН}	V _{IH} or V _{IL}	-0.02	4.5	4.4	-	-	4.4	-	4.4	-	٧
High Level Output Voltage TTL Loads			-6	4.5	3.98	-	-	3.84	-	3.7	-	٧
Low Level Output Voltage CMOS Loads	V _{OL}	V _{IH} or V _{IL}	0.02	4.5	-	-	0.1	-	0.1	-	0.1	٧
Low Level Output Voltage TTL Loads			6	4.5	-	-	0.26	-	0.33	-	0.4	٧
Input Leakage Current	Ιį	V _{CC} to GND	0	5.5	-	-	±0.1	-	±1	-	±1	μА
Quiescent Device Current	lcc	V _{CC} or GND	0	5.5	-	-	8	-	80	-	160	μА
Additional Quiescent Device Current Per Input Pin: 1 Unit Load (Note 4)	Δl _{CC}	V _{CC} -2.1	-	4.5 to 5.5	-	100	360	-	450	-	490	μΑ
Three-State Leakage Current	loz	V _{IL} or V _{IH}	-	5.5	-	-	±0.5	-	±5	-	±10	μА

NOTE:

^{4.} For dual-supply systems theoretical worst case ($V_I = 2.4V$, $V_{CC} = 5.5V$) specification is 1.8mA.

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HCT Input Loading Table

INPUT	UNIT LOADS
Data	0.5
S	1.5
ŌĒ	1.5

NOTE: Unit Load is ΔI_{CC} limit specified in DC Electrical Specifications table, e.g., 360μA max at 25°C.

Switching Specifications Input t_n t_f = 6ns

		TEST		25 ⁰ C		-40°C TO 85°C	-55°C TO 125°C	
PARAMETER	SYMBOL	CONDITIONS	V _{CC} (V)	TYP	MAX	MAX	MAX	UNITS
Propagation Delay	t _{PLH} , t _{PHL}	C _L = 50pF	4.5	-	27	34	41	ns
In to ₹		C _L = 15pF	5	11	-	-	-	ns
Propagation Delay	t _{PZL,} t _{PZH}	C _L = 50pF	4.5	-	34	43	51	ns
S to ₹		C _L = 15pF	5	14	-	-	-	ns
Propagation Delay	t _{PZL} , t _{PZH}	C _L = 50pF	4.5	-	28	35	42	ns
OE to Y		C _L = 15pF	5	11	-	-	-	ns
Propagation Delay	t _{PLZ} , t _{PHZ}	C _L = 50pF	4.5	-	30	38	45	ns
ŌĒ to Ÿ		C _L = 15pF	5	12	-	-	-	ns
Output Transition Times	t _{TLH} , t _{THL}	C _L = 50pF	4.5	-	12	15	18	ns
Input Capacitance	Cl	-	-	-	10	10	10	pF
Three-State Output Capacitance	СО	-	-	-	20	20	20	pF
Power Dissipation Capacitance (Notes 5, 6)	C _{PD}	-	5	49	-	-	-	pF

NOTES:

- 5. C_{PD} is used to determine the dynamic power consumption, per multiplexer.
- 6. $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ where $f_i = Input$ Frequency, $C_L = Output$ Load Capacitance, $V_{CC} = Supply$ Voltage.

Test Circuits and Waveforms

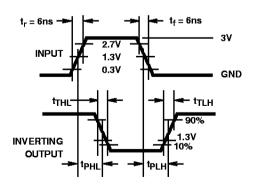


FIGURE 1. HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

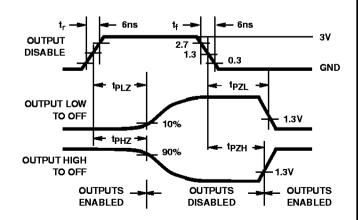
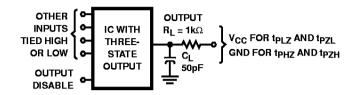


FIGURE 2. HCT THREE-STATE PROPAGATION DELAY WAVEFORM

Test Circuits and Waveforms (Continued)



NOTE: Open drain waveforms t_{PLZ} and t_{PZL} are the same as those for three-state shown on the left. The test circuit is Output $R_L = 1k\Omega$ to V_{CC} , $C_L = 50pF$.

FIGURE 3. HCT THREE-STATE PROPAGATION DELAY TEST CIRCUIT

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